

**AMENDMENT TO THE SPECIFICATION**

Please replace paragraph [0021] with the following amended paragraph:

Figs. 4a-4c illustrate an example of the shield substrate sealing method according to one example of the present disclosure. Fig. 4a is a top view of the sealant region of an organic EL display device while Fig. 4b and 4c are sectional view thereof. The device substrate 402 comprises the organic EL display device, which comprises, for example, the OLED multi-layer pixel structure as shown in FIG. 1. As shown, instead of a continuous organic polymer layer, the organic polymer layer 404 has stripes of narrow openings 405 processed thereon, which may be referred to as a slit structure. This can be done by masking out certain areas from polymer formation, provided that this slit structure does not affect the need of the organic polymer for the active pixel regions. The sealant region 403 is located perpendicular to the openings 405. As such, in selected locations of the openings 405, the exposed areas of substrate 402, which may be a dielectric layer, can receive sealant.